



Min

4.03

6.40

1.10

5.01

4.37

.71

.36

1.73

3A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

POWERMITE[®]3

Max

4.09

6.61

1.14

5.17

4.43

.77

.46

1.83

.889 NOM

1.83 NOM

.178 NOM

.178 NOM

Features

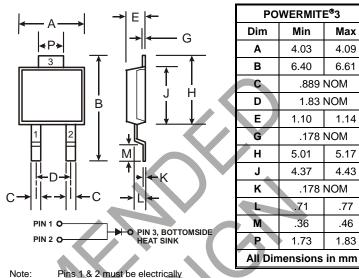
- Guard Ring Die Construction for Transient Protection •
- Low Power Loss, High Efficiency •
- Low Reverse Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant Version (Note 2)

Mechanical Data

- Case: POWERMITE®3 •
- Case Material: Molded Plastic: UL Flammability . Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish). @3
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3

. ...

Weight: 0.072 grams (approximate)



Pins 1 & 2 must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Rectified Output Current (See also Figure 5)	lo	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load @ $T_{C} = 25^{\circ}C$ @ $T_{C} = 100^{\circ}C$	IFSM	100 50	A
Typical Thermal Resistance Junction to Soldering Point	R _{0JS}	3.2	°C/W
Operating Temperature Range	Tj	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

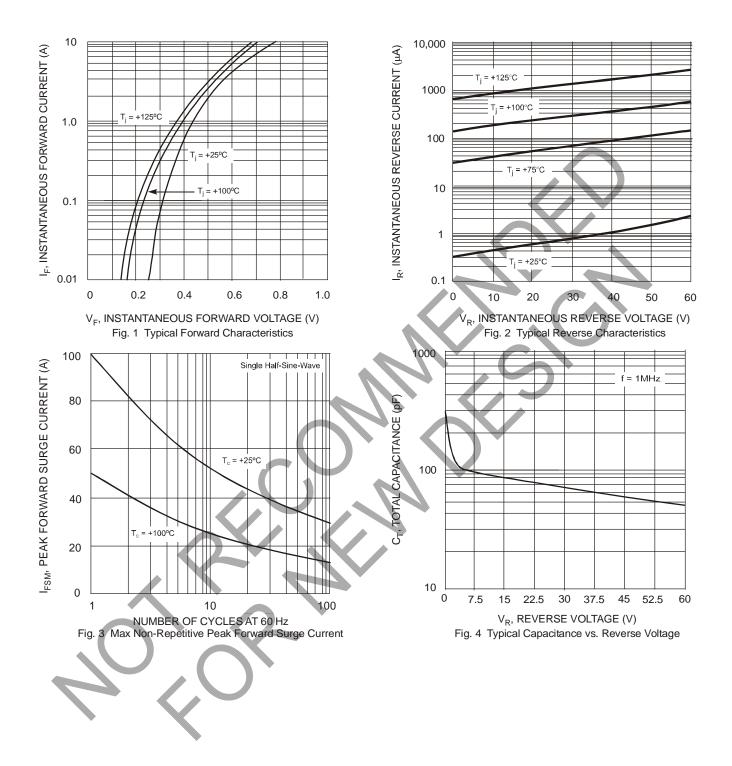
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	60	_		V	$I_R = 0.2mA$
Forward Voltage	Vfm		0.59 0.53 0.72 0.63	0.63 0.57 0.76 0.67	V	$ \begin{split} I_F &= 3A, \ T_j = \ 25^\circ C \\ I_F &= 3A, \ T_j = \ 125^\circ C \\ I_F &= 6A, \ T_j = \ 25^\circ C \\ I_F &= 6A, \ T_j = \ 125^\circ C \end{split} $
Reverse Current (Note 1)	I _{RM}		2.0 0.6 2.5	200 20 150	μA mA mA	$ \begin{array}{l} T_{j} = \ 25^{\circ}\text{C}, \ V_{R} = 60\text{V} \\ T_{j} = 100^{\circ}\text{C}, \ V_{R} = 60\text{V} \\ T_{j} = 125^{\circ}\text{C}, \ V_{R} = 60\text{V} \end{array} $
Total Capacitance	CT	—	130		pF	$f = 1.0MHz, V_R = 4.0V DC$

Notes: 1. Short duration pulse test used to minimize self-heating effect.

2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

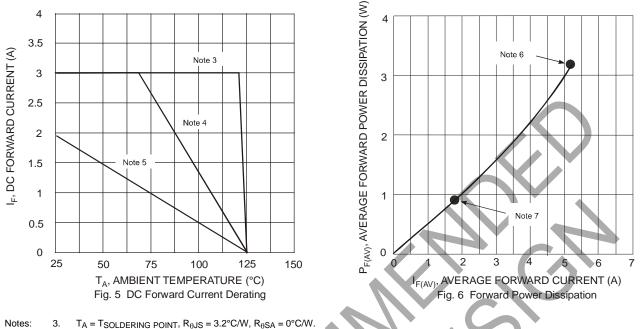


NOT RECOMMENDED FOR NEW DESIGN USE PDS360





NOT RECOMMENDED FOR NEW DESIGN **USE PDS360**



- 3. 4. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{0JA} in range of 20-40°C/W.
 - Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout 5. document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R_{0JA} in range of 100-120°C/W.
 - Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 5. 6.
 - 7.

Ordering Information (Note 8)

Device	Packaging	Shipping
MBRM360-13-F	POWERMITE [®] 3	5000/Tape & Reel

8. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. Notes:

Marking Information



MBRM360 = Product type marking code
 Miskinstol = Product type marking code

 J1: = Manufacturers' code marking

 YYWW = Date code marking

 YY = Last digit of year (ex: 02 for 2002)

 WW = Week code (01 to 53)

 (K) = Factory Designator



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

- 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2010, Diodes Incorporated

www.diodes.com



单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达尔科技)